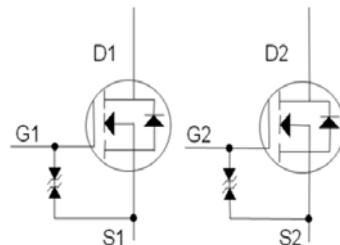


**Dual N-Channel Logic Level Enhancement Mode Field Effect Transistor**

**Product Summary:**

|                          |      |
|--------------------------|------|
| BV <sub>DSS</sub>        | 20V  |
| R <sub>DSON</sub> (MAX.) | 20mΩ |
| I <sub>D</sub>           | 8A   |



Pb-Free Lead Plating & Halogen Free

ESD Protection



**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     |                        | SYMBOL                            | LIMITS     | UNIT |
|--|------------------------|-----------------------------------|------------|------|
| Gate-Source Voltage                            |                        | V <sub>GS</sub>                   | ±12        | V    |
| Continuous Drain Current                       | T <sub>A</sub> = 25 °C | I <sub>D</sub>                    | 8          | A    |
|  | T <sub>A</sub> = 70 °C |                                   | 6          |      |
| Pulsed Drain Current <sup>1</sup>              |                        | I <sub>DM</sub>                   | 32         |      |
| Power Dissipation                              | T <sub>A</sub> = 25 °C | P <sub>D</sub>                    | 2.27       | W    |
|  | T <sub>A</sub> = 70 °C |                                   | 1.45       |      |
| Operating Junction & Storage Temperature Range |                        | T <sub>j</sub> , T <sub>stg</sub> | -55 to 150 | °C   |

**THERMAL RESISTANCE RATINGS**

| THERMAL RESISTANCE               | SYMBOL           | TYPICAL | MAXIMUM | UNIT   |
|----------------------------------|------------------|---------|---------|--------|
| Junction-to-Case                 | R <sub>θJC</sub> | 7.5     | 55      | °C / W |
| Junction-to-Ambient <sup>3</sup> | R <sub>θJA</sub> |         |         |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle ≤ 1%

<sup>3</sup>55°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER   | SYMBOL               | TEST CONDITIONS   | LIMITS |      |          | UNIT             |
|---|----------------------|---|--------|------|----------|------------------|
|   |                      |   | MIN    | TYP  | MAX      |                  |
| STATIC  |                      |   |        |      |          |                  |
| Drain-Source Breakdown Voltage  | $V_{(\text{BR})DSS}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$                       | 20     |      |          | V                |
| Gate Threshold Voltage  | $V_{GS(\text{th})}$  | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                   | 0.4    | 0.75 | 1.2      |                  |
| Gate-Body Leakage   | $I_{GSS}$            | $V_{DS} = 0V, V_{GS} = \pm 12V$                           |        |      | $\pm 10$ | $\mu\text{A}$    |
| Zero Gate Voltage Drain Current   | $I_{DSS}$            | $V_{DS} = 16V, V_{GS} = 0V$                               |        |      | 1        | $\mu\text{A}$    |
|   |                      | $V_{DS} = 16V, V_{GS} = 0V, T_J = 125^\circ\text{C}$      |        |      | 10       |                  |
| On-State Drain Current <sup>1</sup>   | $I_{D(\text{ON})}$   | $V_{DS} = 5V, V_{GS} = 4.5V$                              | 8      |      |          | A                |
| Drain-Source On-State Resistance <sup>1</sup>                               | $R_{DS(\text{ON})}$  | $V_{GS} = 4.5V, I_D = 6A$                                 |        | 17   | 20       | $\text{m}\Omega$ |
|   |                      | $V_{GS} = 2.5V, I_D = 3A$                                 |        | 21   | 28       |                  |
| Forward Transconductance <sup>1</sup>                                       | $g_{fs}$             | $V_{DS} = 5V, I_D = 6A$                                   |        | 7    |          | S                |
| DYNAMIC   |                      |   |        |      |          |                  |
| Input Capacitance   | $C_{iss}$            | $V_{GS} = 0V, V_{DS} = 10V, f = 1\text{MHz}$              |        | 964  |          | $\text{pF}$      |
| Output Capacitance  | $C_{oss}$            |   |        | 148  |          |                  |
| Reverse Transfer Capacitance  | $C_{rss}$            |   |        | 129  |          |                  |
| Gate Resistance   | $R_g$                | $V_{GS} = 15\text{mV}, V_{DS} = 0V, f = 1\text{MHz}$      |        | 1.7  |          | $\Omega$         |
| Total Gate Charge <sup>1,2</sup>  | $Q_g$                | $V_{DS} = 10V, V_{GS} = 4.5V, I_D = 4A$                   |        | 11.7 |          | $\text{nC}$      |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$             |   |        | 1.3  |          |                  |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$             |   |        | 3.8  |          |                  |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(\text{on})}$   | $V_{DS} = 10V, I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6\Omega$ |        | 12   |          | $\text{nS}$      |
| Rise Time <sup>1,2</sup>  | $t_r$                |   |        | 15   |          |                  |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(\text{off})}$  |   |        | 30   |          |                  |
| Fall Time <sup>1,2</sup>  | $t_f$                |   |        | 15   |          |                  |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ ) |                      |   |        |      |          |                  |
| Continuous Current  | $I_s$                |   |        |      | 2        | $\text{A}$       |
| Pulsed Current <sup>3</sup>   | $I_{SM}$             |   |        |      | 8        |                  |
| Forward Voltage <sup>1</sup>  | $V_{SD}$             | $I_F = I_s, V_{GS} = 0V$                                  |        |      | 1.2      | V                |

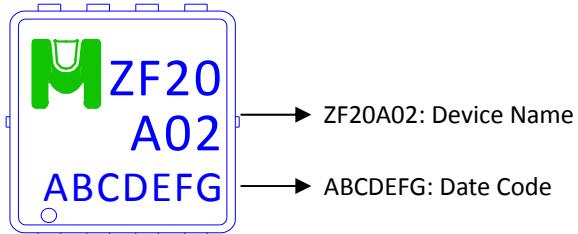
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

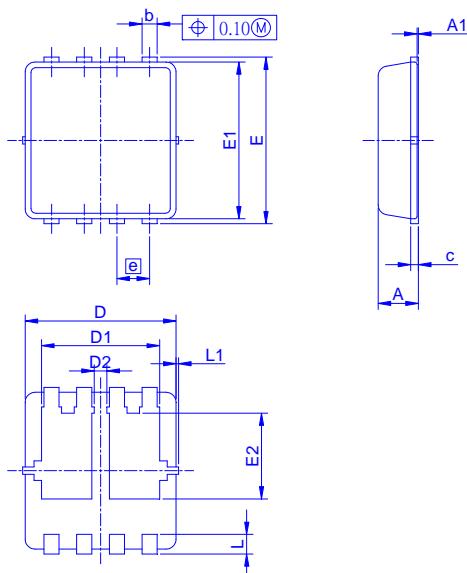
<sup>3</sup>Pulse width limited by maximum junction temperature.

### Ordering & Marking Information:

Device Name: EMZF20A02V for EDFN 3 x 3



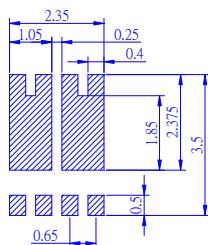
### Outline Drawing



Dimension in mm

| Dimension | A    | A1   | b    | c    | D    | D1   | D2   | E    | E1   | E2   | e    | L    | L1    | $\theta 1$ |
|-----------|------|------|------|------|------|------|------|------|------|------|------|------|-------|------------|
| Min.      | 0.65 | 0    | 0.20 | 0.10 | 2.90 | 2.15 | 0.28 | 3.10 | 2.90 | 1.53 | 0.55 | 0.30 | -     | 0°         |
| Typ.      | 0.75 | -    | 0.30 | 0.15 | 3.00 | 2.47 | 0.38 | 3.20 | 3.00 | 1.81 | 0.65 | 0.40 | 0.075 | 10°        |
| Max.      | 0.90 | 0.05 | 0.40 | 0.25 | 3.30 | 2.75 | -    | 3.50 | 3.30 | 1.98 | 0.75 | 0.50 | 0.150 | 14°        |

### Recommended minimum pads



### TYPICAL CHARACTERISTICS

